

RoHS Compliant Product  
A suffix of "-C" specifies halogen & lead-free

## FEATURES

- Ideal for surface mount applications
- Easy pick and place
- Built-in strain relief

## MECHANICAL DATA

- Case: Molded plastic SMB
- Epoxy: UL 94V-0 rate flame retardant
- Polarity: Color band denotes cathode
- Mounting position: Any

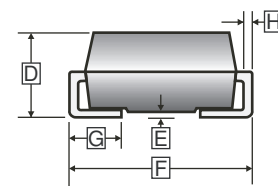
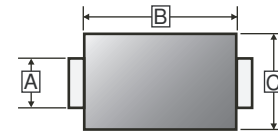
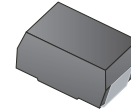
## PACKAGE INFORMATION

Package	MPQ	Leader Size
SMB	3K	13 inch

## ORDER INFORMATION

Part Number	Type
SMF301B-C~SMF307B-C	Lead (Pb)-free and Halogen-free

### SMB



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	1.85	2.20	E	-	0.203
B	4.00	4.75	F	5.08	5.59
C	3.25	3.94	G	0.75	1.52
D	1.99	2.61	H	0.15	0.31

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.  
For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Part Number							Unit
		SMF 301B-C	SMF 302B-C	SMF 303B-C	SMF 304B-C	SMF 305B-C	SMF 306B-C	SMF 307B-C	
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current .375"(9.5mm) Lead Length @ $T_A=55^\circ\text{C}$	$I_F$	3							A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load	$I_{FSM}$	80							A
Maximum Instantaneous Forward Voltage @3A	$V_F$	1.3			1.5	1.7		V	
Maximum DC Reverse Current @Rated DC Blocking Voltage	$T_J=25^\circ\text{C}$	5							$\mu\text{A}$
	$T_J=100^\circ\text{C}$	250							
Maximum Reverse Recovery Time <sup>1</sup>	$T_{RR}$	150			250	500		nS	
Typical Thermal Resistance from Junction-Lead	$R_{\theta JL}$	25							$^\circ\text{C/W}$
Typical Thermal Resistance from Junction-Case <sup>3</sup>	$R_{\theta JC}$	30							
Typical Junction Capacitance <sup>2</sup>	$C_J$	44							pF
Operating & Storage Temperature	$T_J, T_{STG}$	-55~150							$^\circ\text{C}$

### Notes:

1. Reverse Recovery Time test condition:  $I_F=0.5\text{A}$ ,  $I_R=1\text{A}$ ,  $I_{RR}=0.25\text{A}$ .
2. Measured at 1MHz and applied reverse voltage of 4V D.C.
3. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0mm<sup>2</sup> (0.013mm thick) copper pads as heat sink.

**RATINGS AND CHARACTERISTIC CURVES**

FIG.1-TYPICAL FORWARD CHARACTERISTICS

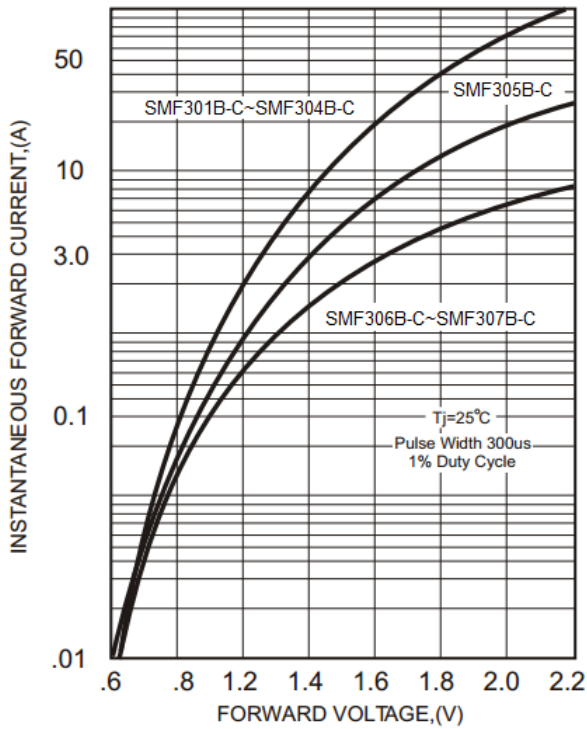


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

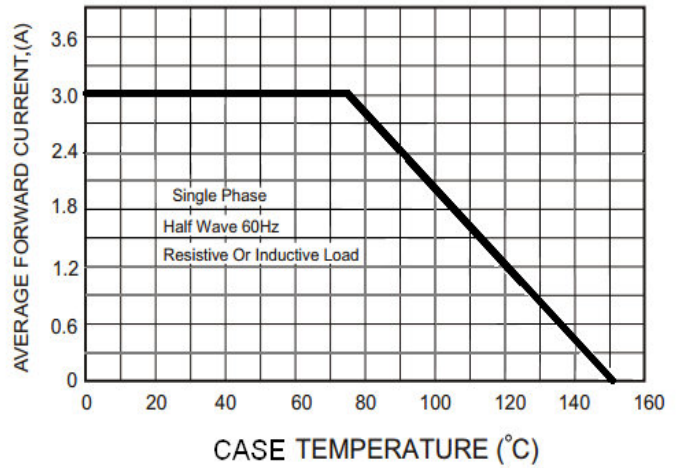


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

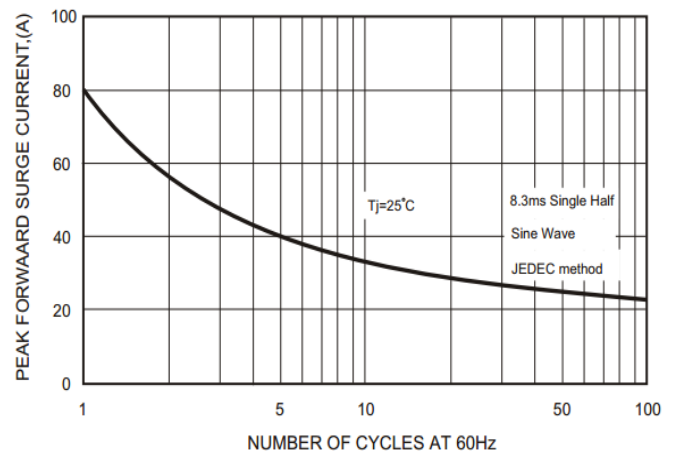
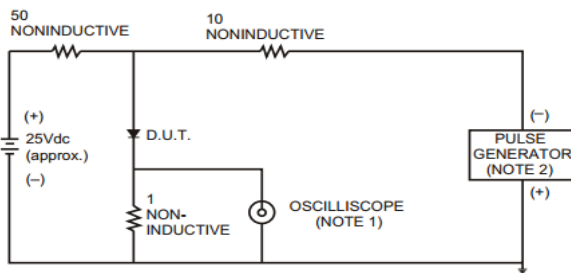


FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm.22pF.  
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

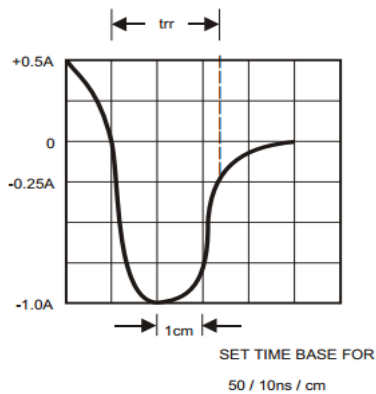


FIG.5-TYPICAL JUNCTION CAPACITANCE

